

Freescale Semiconductor

100 kPa On-Chip Temperature Compensated Silicon Pressure Sensors

The MPX2102 series devices are silicon piezoresistive pressure sensors providing a highly accurate and linear voltage output directly proportional to the applied pressure. The sensor is a single, monolithic silicon diaphragm with the strain gauge and a thin-film resistor network integrated on chip. The chip is laser trimmed for precise span and offset calibration and temperature compensation.

Features

- Temperature Compensated Over 0°C to +85°C
- Easy-to-Use Chip Carrier Package Options
- Available in Absolute, Differential and Gauge Configurations
- Absolute, Differential and Gauge Options

Document Number: MPX2102 Rev 9, 01/2012

MPX2102 Series

0 to 100 kPa (0 to 14.5 psi) 40 mV Full Scale (Typical)

Application Examples

- Pump/Motor Control
- Robotics
- Level Detectors
- Medical Diagnostics
- Pressure Switching
- Barometers
- Altimeters

| | ORDERING INFORMATION | | | | | | | | | |
|-------------------|----------------------|---------|------|------------|------|-------|---------------|----------|----------------|--|
| Device Name | Package | Case | | # of Ports | | | Pressure Type | 9 | Device Marking | |
| | Options | No. | None | Single | Dual | Gauge | Differential | Absolute | Device Marking | |
| Unibody Package | (MPX2102 Series) | | | | | | | | | |
| MPX2102A | Tray | 344 | • | | | | | ٠ | MPX2102A | |
| MPX2102AP | Tray | 344B | | • | | | | • | MPX2102AP | |
| MPX2102ASX | Tray | 344F | | • | | | | ٠ | MPX2102A | |
| MPX2102DP | Tray | 344C | | | • | | • | | MPX2102DP | |
| MPX2102GP | Tray | 344B | | • | | • | | | MPX2102GP | |
| MPX2102GVP | Tray | 344D | | • | | • | | | MPX2102GVP | |
| Small Outline Pac | kage (MPXV2102G | Series) | | | | • | • | | • | |
| MPXV2102GP | Tray | 1369 | | • | | • | | | MPXV2102GP | |
| MPAK Package (M | IPXM2102 Series) | | | | | • | | | | |
| MPXM2102A | Rail | 1320 | • | | | | | • | MPXM2102A | |
| MPXM2102AT1 | Tape and Reel | 1320 | • | | | | | • | MPXM2102A | |
| MPXM2102AS | Rail | 1320A | | • | | | | ٠ | MPXM2102AS | |
| MPXM2102AST1 | Tape and Reel | 1320A | | • | | | | ٠ | MPXM2102AS | |
| MPXM2102D | Rail | 1320 | • | | | | • | | MPXM2102D | |
| MPXM2102DT1 | Tape and Reel | 1320 | • | | | | • | | MPXM2102D | |
| MPXM2102GS | Rail | 1320A | | • | | • | | | MPXM2102GS | |
| MPXM2102GST1 | Tape and Reel | 1320A | | • | | • | | | MPXM2102GS | |



MPX2102A

CASE 344

UNIBODY PACKAGES



MPX2102AP/GP CASE 344B



MPX2102DP CASE 344C



MPX2102GVP CASE 344D

MPAK



MPX2102ASX CASE 344F

SMALL OUTLINE PACKAGE

MPXV2102GP CASE 1369

MPXM2102A/ATI MPXM2102D/DT1 CASE 1320



MPXM2102AS/AST1 MPXM2102GS/AS CASE 1320A

Operating Characteristics

| Table 1. Operating Characteristics | s (V _S = 10 V _D | _C , T _A = 25°C unless o | therwise noted, P1 > P2) |
|------------------------------------|---------------------------------------|---|--------------------------|
|------------------------------------|---------------------------------------|---|--------------------------|

| Characteristic | Symbol | Min | Тур | Max | Units |
|---|--------------------------------------|------------------------------|------|--------------------------|--|
| Pressure Range ⁽¹⁾ Absolute Pressure Range MPX2102A Differential Pressure Range MPX2102D | P _{OP} P _{OP} | 20 0 | | 100 100 | kPa kPa |
| Supply Voltage ⁽²⁾ | V _S | _ | 10 | 16 | V _{DC} |
| Supply Current | Ι _Ο | _ | 6.0 | _ | mAdc |
| Full Scale Span ⁽³⁾ | V _{FSS} | 38.5 | 40 | 41.5 | mV |
| Offset ⁽⁴⁾ MPX2102D Series MPX2102A Series MPXM2102D/G Series MPXM2102A Series | V _{OFF} V _{OFF} | -1.0 -2.0 -1.0 -2.0 | | 1.0 2.0 1.0 2.0 | mV mV |
| Sensitivity | $\Delta V / \Delta P$ | — | 0.4 | — | mV/kPa |
| Linearity ⁽⁵⁾ MPX2102D Series MPX2102A Series MPXM2102D/G Series MPXM2102A Series | | -0.6 -1.0 -0.6 -1.0 | | 0.4 1.0 0.4 1.0 | %V _{FSS} %V _{FSS} |
| Pressure Hysteresis ⁽⁵⁾ (0 to 100 kPa) | _ | _ | ±0.1 | _ | %V _{FSS} |
| Temperature Hysteresis ⁽⁵⁾ (-40°C to +125°C) | — | — | ±0.5 | _ | %V _{FSS} |
| Temperature Coefficient of Full Scale Span ⁽⁵⁾ | TCV _{FSS} | -2.0 | — | 2.0 | %V _{FSS} |
| Temperature Coefficient of Offset ⁽⁵⁾ | TCV _{OFF} | -1.0 | — | 1.0 | mV |
| Input Impedance | Z _{IN} | 1000 | | 2500 | W |
| Output Impedance | Z _{OUT} | 1400 | | 3000 | W |
| Response Time ⁽⁶⁾ (10% to 90%) | t _R | _ | 1.0 | | ms |
| Warm-Up Time | _ | _ | 20 | | ms |
| Offset Stability ⁽⁷⁾ | _ | _ | ±0.5 | _ | %V _{FSS} |

1. 1.0 kPa (kiloPascal) equals 0.145 psi.

2. Device is ratiometric within this specified excitation range. Operating the device above the specified excitation range may induce additional error due to device self-heating.

3. Full Scale Span (V_{FSS}) is defined as the algebraic difference between the output voltage at full rated pressure and the output voltage at the minimum related pressure.

- 4. Offset (V_{OFF}) is defined as the output voltage at the minimum rated pressure.
- 5. Accuracy (error budget) consists of the following:

Linearity: Output deviation from a straight line relationship with pressure, using end point method, over the specified pressure range. Temperature Hysteresis:Output deviation at any temperature within the operating temperature range, after the temperature is cycled to and from the minimum or maximum operating temperature points, with zero differential pressure applied.

Pressure Hysteresis: Output deviation at any pressure with the specified range, when this pressure is cycled to and from the minimum or maximum rated pressure at 25°C.

TcSpan: Output deviation at full rated pressure over the temperature range of 0 to 85°C, relative to 25°C.

TcOffset: Output deviation with minimum rated pressure applied, over the temperature range of 0 to 85°C, relative to 25°C.

6. Response Time is defined as the time from the incremental change in the output to go from 10% to 90% of its final value when subjected to a specified step change in pressure.

7. Offset stability is the product's output deviation when subjected to 1000 hours of Pulsed Pressure, Temperature Cycling with Bias Test.



Maximum Ratings

Table 2. Maximum Ratings⁽¹⁾

| Rating | Symbol | Value | Unit |
|----------------------------|------------------|-------------|------|
| Maximum Pressure (P1 > P2) | P _{MAX} | 400 | kPa |
| Storage Temperature | T _{STG} | -40 to +125 | °C |
| Operating Temperature | T _A | -40 to +125 | °C |

1. Exposure beyond the specified limits may cause permanent damage or degradation to the device.

Voltage Output vs. Applied Differential

The differential voltage output of the sensor is directly proportional to the differential pressure applied.

The absolute sensor has a built-in reference vacuum. The output voltage will decrease as vacuum, relative to ambient, is drawn on the pressure (P1) side.

The output voltage of the differential or gauge sensor increases with increasing pressure applied to the pressure

(P1) side relative to the vacuum (P2) side. Similarly, output voltage increases as increasing vacuum is applied to the vacuum (P2) side relative to the pressure (P1) side.

Figure 1 illustrates a block diagram of the internal circuitry on the stand-alone pressure sensor chip.

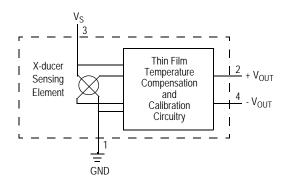


Figure 1. Temperature Compensated Pressure Sensor Schematic



On-Chip Temperature Compensation and Calibration

Figure 2 shows the output characteristics of the MPX2102 series at 25°C. The output is directly proportional to the differential pressure and is essentially a straight line.

The effects of temperature on Full Scale Span and Offset are very small and are shown under Operating Characteristics.

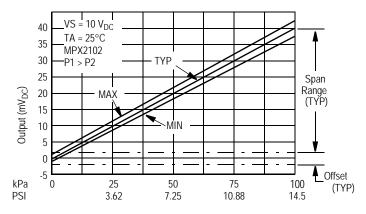


Figure 2. Output vs. Pressure Differential

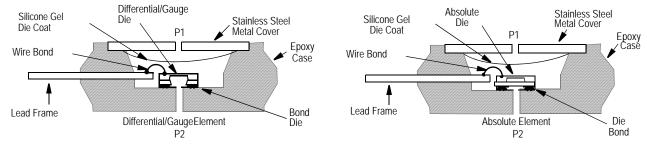




Figure 3 illustrates the absolute sensing configuration (right) and the differential or gauge configuration in the basic chip carrier (Case 344). A silicone gel isolates the die surface and wire bonds from the environment, while allowing the pressure signal to be transmitted to the silicon diaphragm.

The MPX2102 series pressure sensor operating characteristics and internal reliability and qualification tests are based on use of dry air as the pressure media. Media other than dry air may have adverse effects on sensor performance and long term reliability. Contact the factory for information regarding media compatibility in your application.

LINEARITY

Linearity refers to how well a transducer's output follows the equation: $V_{OUT} = V_{OFF}$ + sensitivity x P over the operating pressure range. There are two basic methods for calculating nonlinearity: (1) end point straight line fit (see Figure 4) or (2) a least squares best line fit. While a least squares fit gives the "best case" linearity error (lower numerical value), the calculations required are burdensome.

Conversely, an end point fit will give the "worst case" error (often more desirable in error budget calculations) and the calculations are more straightforward for the user. Freescale's specified pressure sensor linearities are based on the end point straight line method measured at the midrange pressure.

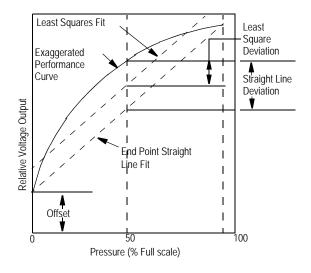


Figure 4. Linearity Specification Comparison



PRESSURE (P1)/VACUUM (P2) SIDE IDENTIFICATION TABLE

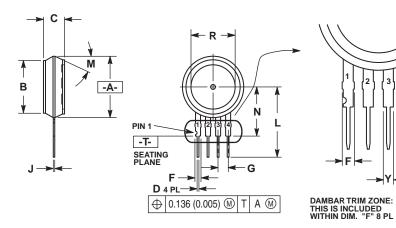
Freescale designates the two sides of the pressure sensor as the Pressure (P1) side and the Vacuum (P2) side. The Pressure (P1) side is the side containing the silicone gel which isolates the die. The differential or gauge sensor is designed to operate with positive differential pressure applied, P1 > P2. The absolute sensor is designed for vacuum applied to P1 side.

The Pressure (P1) side may be identified by using Table 3.

Table 3. Pressure (P1) Side Delineation

| Part Number | Case Type | Pressure (P1) Side Identifier |
|---|--------------|----------------------------------|
| MPX2102A | 344 | Stainless Steel Cap |
| MPX2102DP | 344C | Side with Part Marking |
| MPX2102AP, MPX2102GP | 344B | Side with Port Attached |
| MPX2102GVP | 344D | Stainless Steel Cap |
| MPX2102ASX | 344F | Side with Port Marking |
| MPXV2102GP | 1369 | Side with Port Attached |
| MPXM2102A, MPX2102ATI, MPXM2102D, MPXM2102DT1 | 1320 | Stainless Steel Cap |
| MPXM2102AS, MPXM2102GS, MPXM2102ASTI, MPXM2102GSTI | 1320A | Side with Port Attached |





NOTES:

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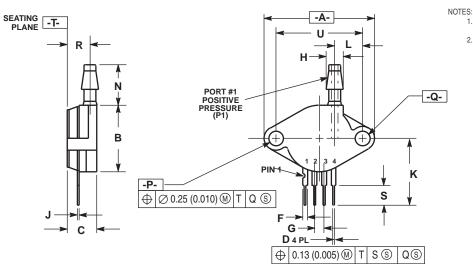
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DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: INCH.
 DIMENSION -A- IS INCLUSIVE OF THE MOLD STOP RING. MOLD STOP RING NOT TO EXCEED 16.00 (0.630).

| | INC | HES | MILLIMETERS | | |
|-----|-------------|-------|-------------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 0.595 | 0.630 | 15.11 | 16.00 | |
| В | 0.514 | 0.534 | 13.06 | 13.56 | |
| С | 0.200 | 0.220 | 5.08 | 5.59 | |
| D | 0.016 | 0.020 | 0.41 | 0.51 | |
| F | 0.048 0.064 | | 1.22 | 1.63 | |
| G | 0.100 |) BSC | 2.54 BSC | | |
| J | 0.014 | 0.016 | 0.36 | 0.40 | |
| L | L 0.695 (| | 17.65 | 18.42 | |
| Μ | 30° | NOM | 30° I | NOM | |
| Ν | 0.475 | 0.495 | 12.07 | 12.57 | |
| R | 0.430 | 0.450 | 10.92 | 11.43 | |
| Y | 0.048 | 0.052 | 1.22 | 1.32 | |
| Z | 0.106 | 0.118 | 2.68 | 3.00 | |

CASE 344-15 **ISSUE AA UNIBODY PACKAGE**



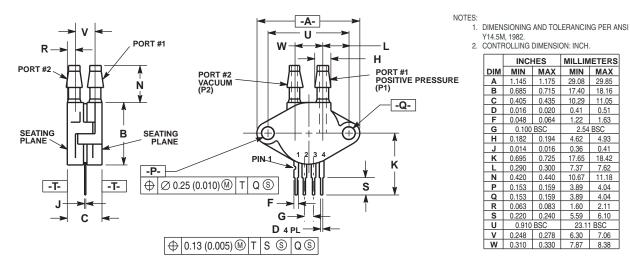
DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

| | INC | HES | MILLIMETER | | |
|-----|------------|-------|------------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 1.145 | 1.175 | 29.08 | 29.85 | |
| В | 0.685 | 0.715 | 17.40 | 18.16 | |
| С | 0.305 | 0.325 | 7.75 | 8.26 | |
| D | 0.016 | 0.020 | 0.41 | 0.51 | |
| F | 0.048 | 0.064 | 1.22 | 1.63 | |
| G | 0.10 |) BSC | 2.54 | BSC | |
| Н | 0.182 | 0.194 | 4.62 | 4.93 | |
| J | 0.014 | 0.016 | 0.36 | 0.41 | |
| κ | 0.695 | 0.725 | 17.65 | 18.42 | |
| L | 0.290 | 0.300 | 7.37 | 7.62 | |
| Ν | 0.420 0.44 | 0.440 | 10.67 | 11.18 | |
| Ρ | 0.153 | 0.159 | 3.89 | 4.04 | |
| Q | 0.153 | 0.159 | 3.89 | 4.04 | |
| R | 0.230 | 0.250 | 5.84 | 6.35 | |
| S | 0.220 | 0.240 | 5.59 | 6.10 | |
| U | 0.910 |) BSC | 23.11 | I BSC | |

CASE 344B-01 ISSUE B UNIBODY PACKAGE





| | INC | IES | MILLIMETERS | | |
|-----|-----------|-------|-------------|-------|--|
| DIM | MIN MAX | | MIN | MAX | |
| Α | 1.145 | 1.175 | 29.08 | 29.85 | |
| В | 0.685 | 0.715 | 17.40 | 18.16 | |
| С | 0.405 | 0.435 | 10.29 | 11.05 | |
| D | 0.016 | 0.020 | 0.41 | 0.51 | |
| F | 0.048 | 0.064 | 1.22 | 1.63 | |
| G | 0.100 | BSC | 2.54 BSC | | |
| н | 0.182 | 0.194 | 4.62 | 4.93 | |
| J | 0.014 | 0.016 | 0.36 | 0.41 | |
| K | 0.695 | 0.725 | 17.65 | 18.42 | |
| L | 0.290 | 0.300 | 7.37 | 7.62 | |
| Ν | 0.420 | 0.440 | 10.67 | 11.18 | |
| Р | 0.153 | 0.159 | 3.89 | 4.04 | |
| Q | 0.153 | 0.159 | 3.89 | 4.04 | |
| R | 0.063 | 0.083 | 1.60 | 2.11 | |
| S | 0.220 | 0.240 | 5.59 | 6.10 | |
| U | 0.910 BSC | | 23.1 | 1 BSC | |
| V | 0.248 | 0.278 | 6.30 | 7.06 | |
| W | 0.310 | 0.330 | 7.87 | 8.38 | |

Y14.5M, 1982.

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MILLIMETERS

MIN MAX

29.85

18.16

8.26

0.51

1.63

0.41

18.42

7.62

11.18

4.04

4.04

 5.84
 6.35

 5.59
 6.10

23.11 BS0

29.08

17.40

7.75

0.41

1.22

0.36

17.65

7 37

10.67

3.89

3.89

2.54 BSC 4.62 4. 4.93

Y14.5M, 1994.

A 1.145

B 0.685

K 0.695

U

INCHES

1.175

0.715

0.725

DIM MIN MAX

C 0.305 0.325 D 0.016 0.020

F 0.048 0.064

G 0.100 BSC H 0.182 0.194

J 0.014 0.016

 L
 0.290
 0.300

 N
 0.420
 0.440

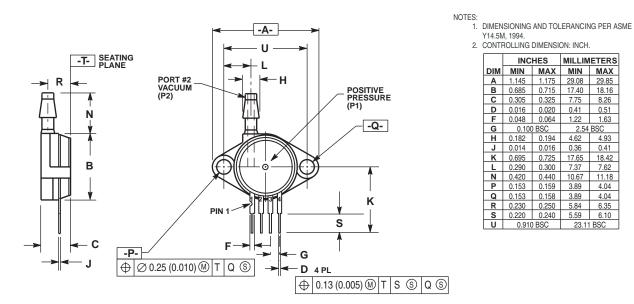
 P
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 0.159

Q 0.153 0.158 R 0.230 0.250

S 0.220 0.240

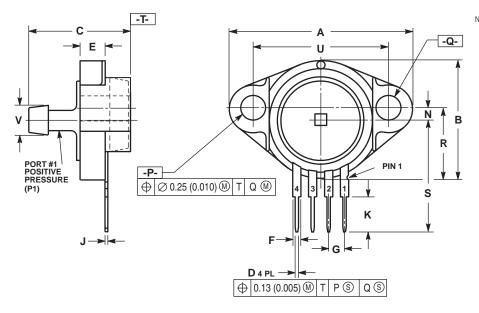
0.910 BSC

CASE 344C-01 **ISSUE B UNIBODY PACKAGE**



CASE 344D-01 **ISSUE B UNIBODY PACKAGE**





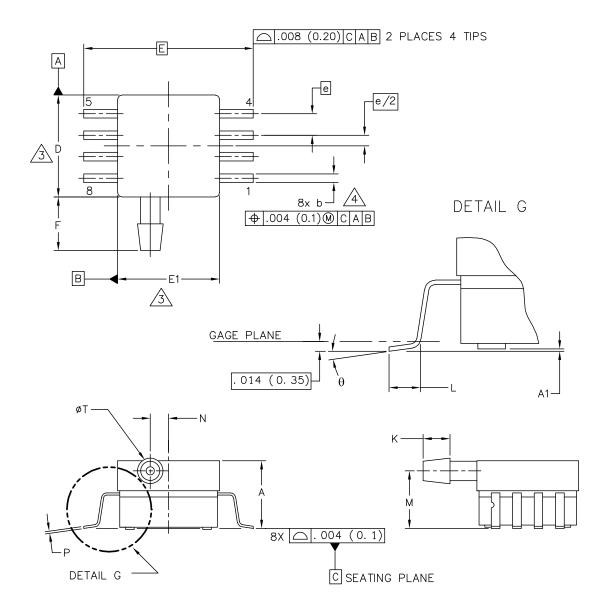
| NOTES: | |
|--------|--|
|--------|--|

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.

| | INC | HES | MILLIMETER | | | | |
|-----|---------------|-------|------------|-------|--|--|--|
| DIM | MIN | MAX | MIN | MAX | | | |
| Α | 1.080 | 1.120 | 27.43 | 28.45 | | | |
| В | 0.740 | 0.760 | 18.80 | 19.30 | | | |
| С | 0.630 | 0.650 | 16.00 | 16.51 | | | |
| D | 0.016 | 0.020 | 0.41 | 0.51 | | | |
| Е | 0.160 0.180 | | 4.06 | 4.57 | | | |
| F | 0.048 | 0.064 | 1.22 | 1.63 | | | |
| G | 0.100 |) BSC | 2.54 BSC | | | | |
| J | J 0.014 0.016 | 0.36 | 0.41 | | | | |
| κ | 0.220 | 0.240 | 5.59 | 6.10 | | | |
| Ν | 0.070 | 0.080 | 1.78 | 2.03 | | | |
| Р | 0.150 | 0.160 | 3.81 | 4.06 | | | |
| Q | 0.150 | 0.160 | 3.81 | 4.06 | | | |
| R | 0.440 0.460 | 0.460 | 11.18 | 11.68 | | | |
| S | 0.695 | 0.725 | 17.65 | 18.42 | | | |
| U | 0.840 | 0.860 | 21.34 | 21.84 | | | |
| ٧ | 0.182 | 0.194 | 4.62 | 4.92 | | | |

CASE 344F-01 **ISSUE B UNIBODY PACKAGE**





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|---|--------------------|-----------------|-------------|
| TITLE: | DOCUMENT N | 0: 98ASA99303D | REV: B |
| 8 LD SOP, SIDE PC | DRT CASE NUMBE | R: 1369–01 | 24 MAY 2005 |
| | STANDARD: N | ON-JEDEC | |

CASE 1369-01 ISSUE B SMALL OUTLINE PACKAGE



CASE 1369-01

PAGE 2 OF 2

MILLIMETERS

| DIM | MIN | MAX | MIN | MAX | DIM | MIN | MAX | MIN | MAX |
|-----|----------------------|--------------|-------|-----------|-----|---------------------|-----------|--------------|-------------|
| A | . 300 | . 330 | 7.11 | 7.62 | θ | 0° | 7° | 0° | 7° |
| A 1 | . 002 | . 010 | 0. 05 | 0. 25 | - | | | | |
| b | . 038 | . 042 | 0.96 | 1.07 | - | | | | |
| D | . 465 | . 485 | 11.81 | 12.32 | - | | | | |
| E | . 717 | BSC | 18 | 3.21 BSC | - | | | | |
| E1 | . 465 | . 485 | 11.81 | 12.32 | - | | | | |
| e | . 100 | BSC | 2. | 2.54 BSC | | | | | |
| F | . 245 | . 255 | 6. 22 | 6.47 | - | | | | |
| к | . 120 | . 130 | 3. 05 | 3. 30 | - | | | | |
| L | . 061 | . 071 | 1. 55 | 1.80 | - | | | | |
| м | . 270 | . 290 | 6.86 | 7.36 | - | | | | |
| N | . 080 | . 090 | 2. 03 | 2. 28 | - | | | | |
| Р | . 009 | . 011 | 0. 23 | 0.28 | - | | | | |
| T | . 115 | . 125 | 2. 92 | 3. 17 | - | | | | |
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| | ALL RIGHTS RESERVED. | | | | | | | | REV: B |
| | | | | | | | | | 24 MAY 2005 |
| | 8 LD SOP, SIDE PORT | | | | | STANDARD: NON-JEDEC | | | |
| | | | | | STA | NUARD: NO | JN-JEDEC | | |

INCHES

NOTES:

Pressure

1. CONTROLLING DIMENSION: INCH

INCHES

2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.

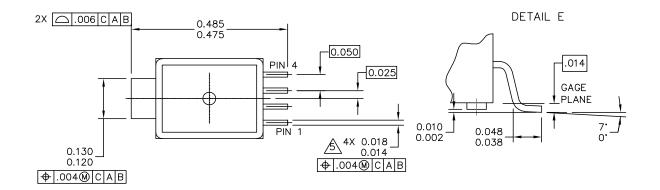
MILLIMETERS

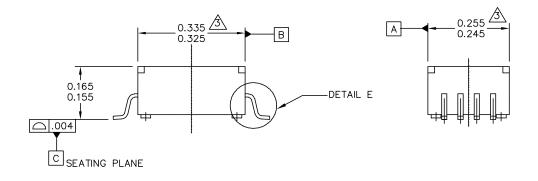
A DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PPROTRUSIONS. MOLD FLASH AND PROTRUSIONS SHALL NOT EXCEED .006 (0.152) PER SIDE.

PACKAGE DIMENSIONS

A DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE .008 (0.203) MAXIMUM.







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|---|---|--------------|------------------|-------------|
| TITLE: | I | DOCUMENT NE | 1: 98ARH99088A | RE∨: B |
| 5 LD M-PAC | С | CASE NUMBER | 2: 1320-02 | 22 JUL 2005 |
| | S | STANDARD: NE | IN-JEDEC | |

CASE 1320-02 ISSUE B MPAK

MPX2102





NOTES:

1. DIMENSIONS ARE IN INCHES.

- 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
- A DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSION. MOLD FLASH OR PROTRUSION SHALL NOT EXCEED .006" PER SIDE.
- 4. ALL VERTICAL SURFACES TO BE 5' MAXIMUM.

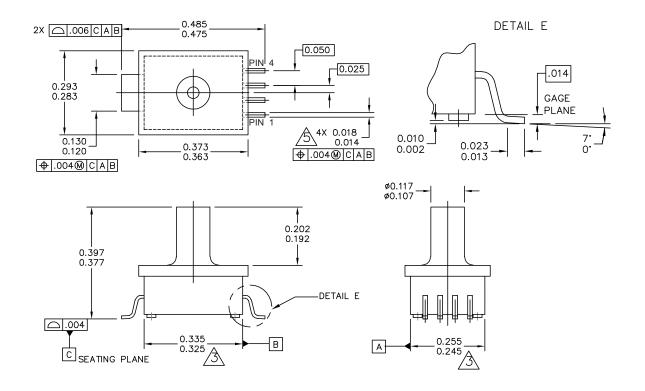
A DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION.

- PIN 1: GND PIN 2: +Vout
- PIN 3: Vs
- PIN 4: -Vout

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|---|-------------------|-------------------|-------------|
| TITLE: | DOCUMEN | NO: 98ARH99088A | REV: B |
| 5 LD M-PAC | CASE NUM | IBER: 1320-02 | 22 JUL 2005 |
| | STANDAR |): NON-JEDEC | |

CASE 1320-02 ISSUE B MPAK





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|---|--------------|-------------|--------------------------|-------------|
| TITLE: | | DOCUMENT NO | : 98ARH99087A | REV: A |
| 5 LD M-PAC, PORTED | | CASE NUMBER | : 1320A-02 | 22 JUL 2005 |
| | STANDARD: NO | N-JEDEC | | |

CASE 1320A-02 ISSUE A MPAK

MPX2102



NOTES:

1. DIMENSIONS ARE IN INCHES.

2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.

A DIMENSIONS DOES NOT INCLUDE MOLD FLASH OR PROTRUSION. MOLD FLASH OR PROTRUSION SHALL NOT EXCEED .006" PER SIDE.

4. ALL VERTICAL SURFACES TO BE 5" MAXIMUM.

5. DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE .008 MAXIMUM.

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|---|---|-----------------------|----------------------------|-------------|
| TITLE: | D | OCUMENT NO | : 98ARH99087A | REV: A |
| 5 LD M-PAC, PORTED | | CASE NUMBER: 1320A-02 | | 22 JUL 2005 |
| | S | TANDARD: NO | N-JEDEC | |

CASE 1320A-02 ISSUE A MPAK



Pressure

| REVISION HISTORY | | | | |
|--------------------|------------------|--|--|--|
| Revision number | Revision date | Description of changes | | |
| 9 | 01/2012 | In Table 1. Operating Characteristics, in the Characteristic column under Pressure Range, added rows for Absolute Pressure Range MPX2102A and Differential Pressure Range MPX2102D devices | | |



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